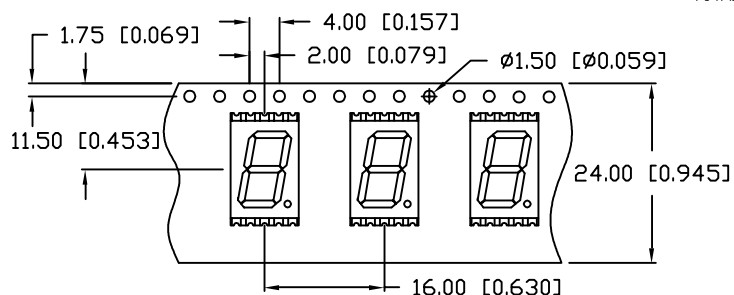
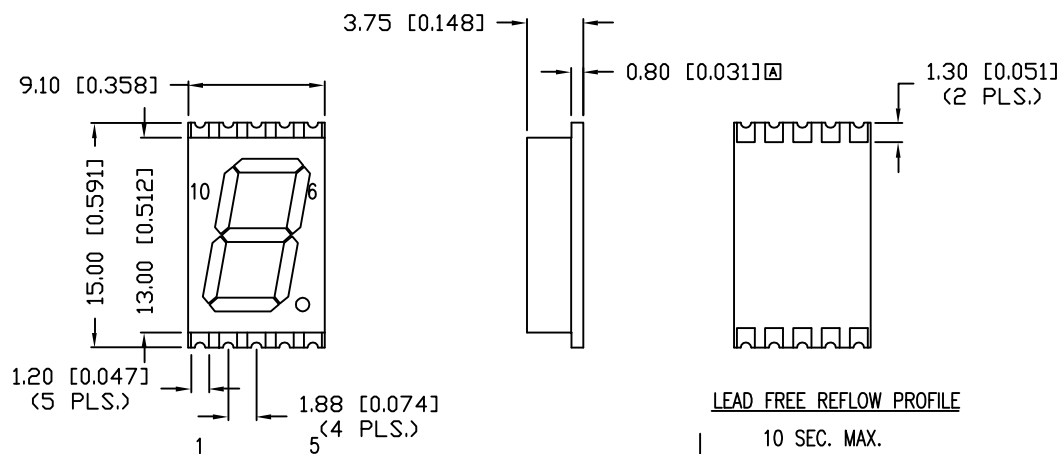


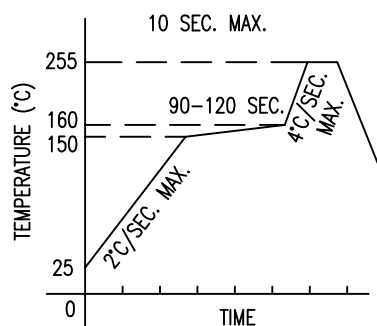
UNCONTROLLED DOCUMENT

PART NUMBER
LDS-SMA4002RIREV.
A

TAPE FEED DIRECTION →

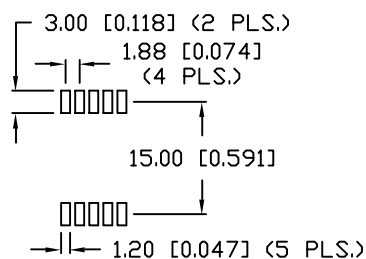
*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.= +DECIMAL PRECISION -0.00 MAX.= +0.00 -DECIMAL PRECISION

LEAD FREE REFLOW PROFILE



TOTAL TIME ABOVE 220°C IS 60 SECONDS MAX.

SOLDER PAD LAYOUT



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=10\text{mA}$					
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		3000		μcd	$I_f=10\text{mA}$
EMITTED COLOR:	GREEN				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

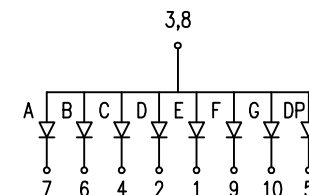
PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C

* $t < 10\mu\text{s}$

NOTES:

1. 800 PCS/REEL

POLARITY DIAGRAM



UNCONTROLLED DOCUMENT

REV.
APART NUMBER
LDS-SMA4002RI

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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0.40" 7 SEGMENT DISPLAY, GRAY FACE,
565nm GREEN CHIPS, WHITE SEGMENTS, COMMON ANODE.

DRAWN BY: GB	CHECKED BY:	APPROVED BY:	DATE: 2.13.03
			PAGE: 1 OF 1
			SCALE: N/A